NCE N-Channel Super Trench Power MOSFET

Description

The NCEP4040Q uses Super Trench technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\text{DS}(\text{ON})}$ and $Q_{\text{g}}.$ This device is ideal for high-frequency switching and synchronous rectification.

Application

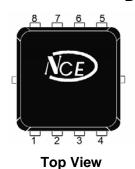
- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

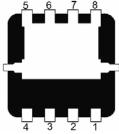
General Features

- V_{DS} =40V,I_D =40A $R_{DS(ON)}$ =7.7m Ω (typical) @ V_{GS} =10V $R_{DS(ON)}$ =11m Ω (typical) @ V_{GS} =4.5V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating

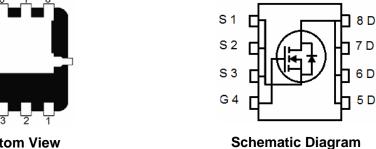
100% UIS TESTED! 100% AVds TESTED!

DFN 3.3X3.3





Bottom View



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP4040Q	NCEP4040Q	DFN3.3X3.3-8L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	40	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	40	А
Drain Current-Continuous(T _C =100°C)	I _D (100℃)	28.3	Α
Pulsed Drain Current	I _{DM}	125	Α
Maximum Power Dissipation	P _D	25	W
Derating factor		0.2	W/°C
Single pulse avalanche energy (Note 5)	E _{AS}	115	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 150	$^{\circ}$ C

Thermal Characteristic

Thermal Resistance,Junction-to-Case ^(Note 2)	R _{θJC}	5	°C/W
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Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	40		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20 V , V_{DS} =0 V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.0	1.6	2.0	V
Drain Course On State Registance	R _{DS(ON)}	V _{GS} =10V, I _D =20A	-	7.7	8.8	mΩ
Drain-Source On-State Resistance		V _{GS} =4.5V, I _D =20A	-	11	13	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =20A		30	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	\/ -20\/\/ -0\/	-	831	-	PF
Output Capacitance	Coss	V_{DS} =20V, V_{GS} =0V, F=1.0MHz	-	318	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.UIVIFIZ	-	24	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	6	-	nS
Turn-on Rise Time	t _r	V_{DD} =20 V , I_{D} =20 A	-	2.8	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =1.6 Ω	-	23	-	nS
Turn-Off Fall Time	t _f		-	3	-	nS
Total Gate Charge	Qg	V -20VI -20A	-	17.6	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =20V, I_{D} =20A, V_{GS} =10V	-	3.5		nC
Gate-Drain Charge	Q _{gd}	V _{GS} -10V	-	3.1		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =20A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	40	Α
Reverse Recovery Time	t _{rr}	$T_J = 25$ °C, $I_F = I_S$	-	11	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	19	-	nC

Notes:

- ${\bf 1.}\ {\bf Repetitive}\ {\bf Rating:}\ {\bf Pulse}\ {\bf width}\ {\bf limited}\ {\bf by}\ {\bf maximum}\ {\bf junction}\ {\bf temperature}.$
- 2. Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\text{C}$,V $_{\text{DD}}$ =20V,V $_{\text{G}}$ =10V,L=0.5mH,Rg=25 Ω

Pb Free Product





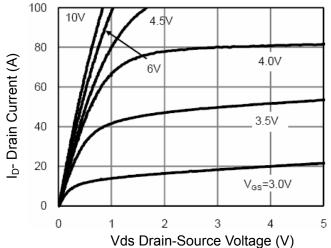


Figure 1 Output Characteristics

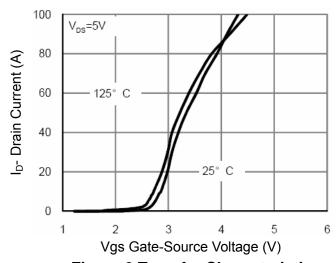


Figure 2 Transfer Characteristics

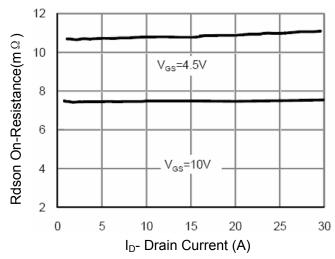


Figure 3 Rdson- Drain Current

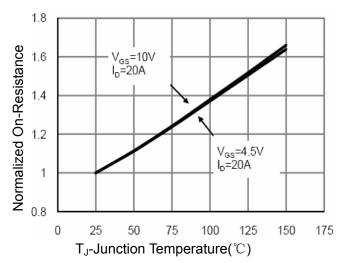


Figure 4 Rdson-Junction Temperature

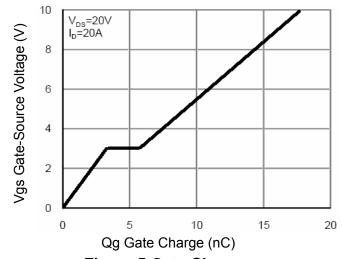


Figure 5 Gate Charge

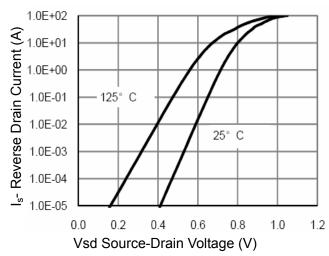


Figure 6 Source- Drain Diode Forward







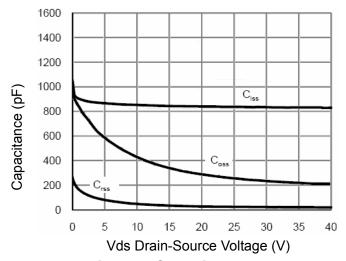


Figure 7 Capacitance vs Vds

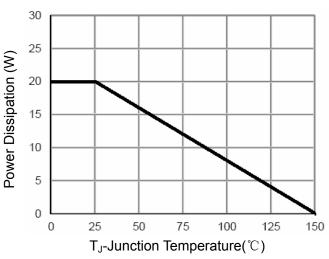


Figure 9 Power De-rating

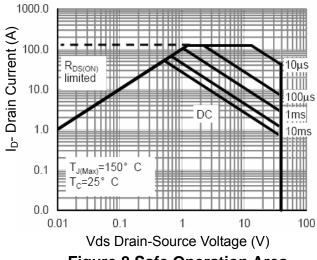


Figure 8 Safe Operation Area

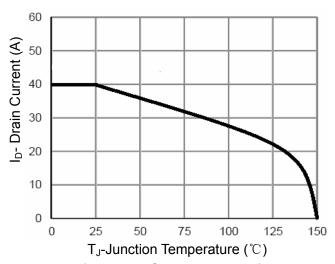


Figure 10 Current De-rating

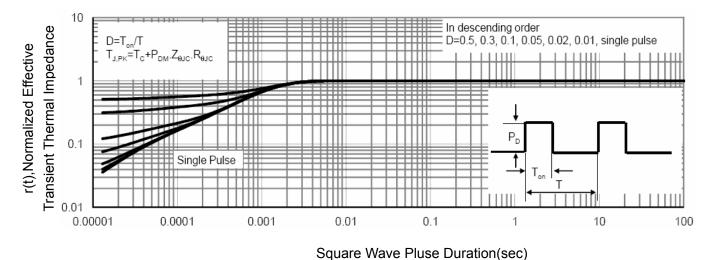
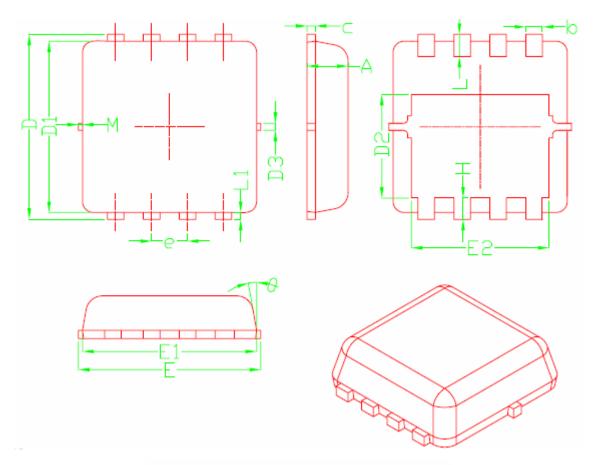


Figure 11 Normalized Maximum Transient Thermal Impedance

DFN3.3X3.3-8L Package Information



arn an or	DIMENSIONAL REOMTS			
SYMBOL	MIN	NOM	MAX	
A	0.70	0.75	0.80	
b	0.25	0.30	0.35	
C	0.10	0.15	0.25	
D	3.25	3.35	3.45	
DI	3.00	3.10	3.20	
D2	1.78	1.88	1.98	
D3		0.13		
E	3.20	3.30	3.40	
E1	3.00	3.15	3.20	
E2	2.39	2.49	2.59	
e	0.65BSC			
H	0.30	0.39	0.50	
L	0.30	0.40	0.50	
L1		0.13		
θ		10°	12°	
M	*	*	0.15	
* Not specified				



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